General Specifications

DAQSTATION DX1000



GS 04L41B01-01E

OVERVIEW

The DX1000 is a DAQSTATION that displays real-time measured data on a color LCD and saves data on a CompactFlash memory card (CF card). It can be hooked up to network via Ethernet, which enables to inform by Email and to monitor on Web site as well as to transfer files by using FTP. Also, it can communicate with Modbus/RTU or Modbus/TCP.

It comes with a two, four, six-channel or twelve-channel model. As the input signal, a DC voltage, thermocouple, resistance temperature detector, or contact signal can be set to each channel. The data saved on a CF card can be converted by data conversion software to Lotus 1-2-3, Excel, or ASCII format file, facilitating processing on a PC. Not only this, the Viewer software allows a PC to display waveforms on its screen and to print out waveforms.



STANDARD SPECIFICATIONS

General Specifications

Construction

Mounting: Flush panel mounting (on a vertical plane)

Mounting may be inclined downward up to 30 degrees from a horizontal plane.

Allowable panel thickness:

2 to 26 mm

Material: Case: drawn steel

Bezel: polycarbonate

Display filter: polycarbonate

Case color:

Case: Grayish blue green

(Munsell 2.0B 5.0/1.7 or equivalent)

Bezel: Charcoal grey light

(Munsell 10B 3.6/0.3 or equivalent)

Front panel:

Water and dust-proof

(based on IEC529-IP65)

Dimensions:

144(W) x 144(H) x 229(D)* mm

*Maximum

Weight: approx. 2.9 kg*

*without optional features

Input

Number of inputs:

DX1002: two channels DX1004: four channels DX1006: six channels DX1012: twelve channels

Measurement interval:

DX1002, DX1004:

125 ms, 250 ms, 25 ms (fast sampling

mode*)

DX1006, DX1012:

1 s (Not available when A/D integration time is set to 100 ms), 2 s, 5 s, 125 ms

(fast sampling mode*)

* A/D integration time is fixed to 1.67 ms in case of

fast sampling mode.

Inputs: DCV (DC voltage), TC (thermocouple), RTD

(resistance temperature detector), DI (digital input for event recording), DCA (DC current with external shunt resistor attached)



Input type	Range	Measuring range				
	20 mV	-20.000 to	20.000 mV			
DCV	60 mV	-60.00 to 60.00 mV				
	200 mV	-200.00 to	200.00 mV			
	2 V	-2.0000 to	2.0000 V			
	6 V	-6.000 to	6.000 V			
	1-5V	-0.800 to	5.200 V			
	20 V	-20.000 to 20.000 V				
	50 V	-50.00 to	50.00 V			
	R*1	0.0 to 1760.0°C	32 to 3200°F			
	S*1	0.0 to 1760.0°C	32 to 3200°F			
	B*1	0.0 to 1820.0°C	32 to 3308°F			
	K*1	-200.0 to 1370.0°C	−328 to 2498°F			
	E*1	−200.0 to 800.0°C	-328.0 to 1472.0°F			
TC	J*1	−200.0 to 1100.0°C	-328.0 to 2012.0°F			
	T*1	−200.0 to 400.0°C	−328.0 to 752.0°F			
	N*1	0.0 to 1300.0°C	32 to 2372°F			
	W*2	0.0 to 2315.0°C	32 to 4199°F			
	L*3	−200.0 to 900.0°C	-328.0 to 1652.0°F			
	U*3	−200.0 to 400.0°C	−328.0 to 752.0°F			
	WRe*4	0.0 to 2400.0°C	32 to 4352°F			
RTD	Pt100*5	−200.0 to 600.0°C	-328.0 to 1112.0°F			
עוט	JPt100*5	–200.0 to 550.0°C	-328.0 to 1022.0°F			
	DCV input	OFF : less than 2.4 \	/			
DI	(TTL)	ON: more than 2.4 \	/			
	Contact input Contact ON/OFF					

- *1 R, S, B, K, E, J, T, N: IEC584-1 (1995), DIN IEC584, JIS C 1602-1995
- *2 W: W-5% Rd/W-26% Rd (Hoskins Mfg. Co.), ASTM E988
- *3 L: Fe-CuNi, DIN43710, U: Cu-CuNi, DIN43710
- *4 WRe: W-3%Re/W-25%Re (Hoskins Mfg. Co.)
- *5 Pt100: JIS C 1604-1997, IEC 751-1995, DIN IEC751-1996 JPt100: JIS C 1604-1989,JIS C 1606-1989 Measuring current: i = 1mA

A/D integration time:

20 ms (50 Hz), 16.7 ms (60 Hz), 100ms (50/60Hz for DX1006/1012), or AUTO selectable (automatic selection by detection of power supply frequency)

A/D integration time is fixed to 1.67 ms (600Hz) in case of fast sampling mode.

Thermocouple burnout:

Burnout upscale/downscale function can be switched on/off (for each channel). Burnout upscale/downscale selectable Normal: Less than 2 k Ω , Burn out: More than 100 k Ω

Detection current: approx. 10 μ A

1-5V range burnout:

Burnout upscale/downscale function can be switched on/off (for each channel). Burnout upscale/downscale selectable Upscale burnout: More than +10% of configured span

Downscale burnout: Less than -5% of configured span

Moving average:

Moving average on/off selectable for each

Moving average cycles 2 to 400 selectable

Calculation:

Differential computation:

Between any two channels Available for DCV, TC, RTD and DI ranges.

Linear scaling:

Available for DCV, TC, RTD and DI ranges.

Scaling limits: -30000 to 30000
Decimhal point: user-selectable

Engineering unit: user-definable, up to 6

characters

Over value: Exceeds ± 5% of scaling

limits (on/off selectable)

Square root:

Available for DCV range. Scaling limits: -30000 to 30000 Decimal point: user-selectable

Engineering unit: user-definable, up to 6

characters

Low level cut off: 0.0 to 5.0% of display

span

Over value: Exceeds ± 5% of scaling

limits (on/off selectable)

1-5VDC scaling:

Available for 1-5VDC range. Scaling limits: -30000 to 30000 Display span limit: 0.800 to 5.200 Decimal point: user-selectable

Engineering unit: user-definable, up to 6

characters

Low level cut off: Fixed to lower span limit Over value: Exceeds ± 5% of scaling limits (on/off selectable)

Display

Display unit:

5.5-inch TFT color LCD (VGA, 320 x 240 pixels)

Note) In the part of crystal display, there are some pixels that can't always turn on or off. Please understand that the brightness of screen looks uneven because of characteristics of crystal display, but it is not out of order.

Display group:

Each measurement channel and computation channel can be assigned to display group of the trend, digital and bargraph display.

Number of display: 10 groups Number of assignable channels for one group: 6 channels

Display color:

Trend/Bargraph:

Selectable from 24 colors

Background:

White or black selectable

Trend display:

Trend display type:

Vertical, horizontal, landscape, horizontal or split selectable

Number of indication channels:

6 channels per display (maximum)

Number of display:

10 displays (10 groups)

Line width:

1, 2, and 3 pixels selectable

Scales: Maximum 6 scales.

Bargraph, green band area and alarm mark can be displayed on scale display. Number of divisions: Selectable from 4 to 12 or C10 (10 divisions by main scale mark and scale values are displayed on 0,

30, 50, 70 and 100% position).

Waveform span rate:

15, 30 sec., 1, 2, 5, 10, 15, 20, 30 min., 1,

2, 4, 10 hours/div selectable

(15 sec/div is available for only DX1002

and DX1004)

Bargraph display:

Direction: Vertical or horizontal selectable

Number of indication channels:

6 channels per display

Number of display:

10 displays (10 groups)

Scales: Green band area and alarm mark can be

displayed on scale display.

Number of divisions: Selectable from 4 to

Reference position: Left, right or center

Display renewal rate: 1 s

Digital indication:

Number of indication channels:

6 channels per display

Number of display:

10 displays (10 groups)

Display renewal rate: 1 s

Overview display:

Number of indication channels:

Measuring values and alarm status of all

channels

Information display:

Alarm summary display:

Display the list of latest 1000 alarms

summary.

Jump to historical trend display by cursor

pointing.

Message summary display:

Display the list of latest 500 messages and

Jump to historical trend display by cursor

pointing.

Memory information:

Display the file list in internal memory.

Jump to historical trend display by cursor

pointing.

Report information:

Display the report data in internal memory.

Modbus status:

Display the Modbus status.

Relay status

Display the on/off status of internal switch

and relay output.

Log display:

Log display types:

Login log, error log, communication log, FTP log, Web log, E-mail log, SNTP log,

DHCP log, Modbus log

Tags:

Number of characters:

16 characters maximum

Messages:

Number of characters:

32 characters maximum

Number of messaged:

100 messages (including 10 free mes-

sages)

Message adding function:

Message can be added on historical

display.

Other display contents:

Status display area:

Date & time (year/month/day,

hour:minute:second), batch name (batch number + lot number), login user name, display name, internal memory status,

status indication icon

Trend display area:

Grid lines (number of divisions selectable from 4 to 12), hour: minutes on grid, trip levels (line widths are selectable from 1, 2

and 3 pixels)

Data referencing function:

Display the retrieved data (display data or event data)

from internal or external memory.

Display format:

Whole display or divided to 2 areas

Time axis operation:

Display magnification or reduction, scroll

by key operation

Display auto scroll function:

Display group of monitor display (trend display, bargraph display and digital display) automatically changes in a preset interval (5, 10, 20, 30 s and 1 min).

LCD saver function:

The LCD backlight automatically dims or off (selectable) if no key is touched for a certain preset time (can be set from 1, 2, 5, 10, 30, and 60 min).

Display register function:

Up to 8 display types can be registered with display name.

Display auto return function:

The display type automatically returns to registerd display type if no key is touched for a certain preset time (can be set from 1, 2, 5, 10, 20, 30 and 60 min)

Temperature unit:

°C or °F selectable

Data Saving Function

External storage medium:

Medium: CompactFlash memory card (CF card)

Format: FAT16 or FAT32

Internal memory:

Flash memory Medium:

Capacity: Selectable from 80MB or 200MB Maximum number of files can be saved:

400 files (total number of display data file

and event data file)

Manual saving:

saving.

Data files in internal memory can be saved manually. Selectable form all data saving or selected data

Drive: CF card or USB flash drive (only for USB option)

Automatic saving:

Display data:

Periodic saving to CF card

Event data:

In case of trigger free...Periodic saving to

CF card

In case of using trigger...Save the data when sampling is finished

Data Saving Period:

Display data file:

Linked with the waveform span rate

Linked with the specified sampling period Event file:

Event File Sampling Period:

DX1002, DX1004:

Selectable from 25, 125, 250, 500 ms, and 1, 2, 5, 10, 30, 60, 120, 300, and 600 s*

DX1006, DX1012:

Selectable from 125, 250, 500 ms, and 1, 2, 5, 10, 30, 60, 120, 300, and 600 s*

*Sampling period faster than measurement interval can not be selected.

Measurement data File:

The following two file types can be created.

Event file (stores instantaneous values sampled periodically at a specified sampling rate)

Display data file (stores the maximum and minimum values for each waveform span rate from among measured data sampled at measurement intervals)

Files can be created in the following combinations.

- (a) Event file + display data file
- (b) Display data file only
- (c) Event file only

Data format: YOKOGAWA private format (Binary)

Maximum data size per file:

8,000,000 byte (8MB)

Data per channel:

Display data file:

Measurement data.....4 byte/data Mathematical data.....8 byte/data

Event data file

Measurement data.....2 byte/data Mathematical data.....4 byte/data Sampling time:

The sampling time per file (8MB) during manual data saving can be determined by the formula "number of data items per channel x interval of data saving." This logic is explained in more detail below:

When handling display data files only
If we assume that the number of measuring
channels is 12, the number of computing channels
is 24, and the display update interval is 30 min/div
(60 sec waveform span rate), then:

Number of data items per channel = 8,000,000 bytes/(8 bytes(time stamp) + 12 x 4 bytes + 24 x 8 bytes) = 32,258 data items
Sampling time per file = 32,258 x 60 sec = 1,935,480 sec = approx. 22 days

2) When handling event files only

If we assume that the number of measuring channels is 12, the number of computing channels is 24, and the data saving interval is 1 sec, then:

Number of data items per channel = 8,000,000 bytes/(8 bytes(time stamp) + 12 x 2 bytes + 24 x 4 bytes) = 62,500 data items
Sampling time per file = 62,500 x 1 sec = 62,500 sec = approx. 17 hours

3) When handling both display data files and event files

The sampling time is calculated by defining the size of data items in a display data file as 8,000,000 bytes and the size of data items in an event data file as 8,000,000 bytes. The method of calculation is the same as shown above.

Examples of Sampling Time for 1 file (8MB)*: *If sampling time exceeds 31 days, data file is divided.

In case measurement ch = 4 ch, mathematical ch = 0 ch

Display data file (approx.)

Waveform span rate (time/div)	15 s	30 s	1 min	2 min	5 min	10 min
Data saving period	0.5 s	1 s	2 s	4 s	10 s	20 s
Sampling time	46.3 h	3 days	7 days	15 days	38 days	77 days

Event data file (approx.)

Data saving period	25 ms	125 ms	0.5 s	1 s	2 s	5 s	10 s
Sampling time	3.5 h	17.4 h	2 days	5 days	11 days	28 days	57 days

In case measurement ch = 12 ch, mathematical ch = 24 ch

Display data file (approx.)

Siopidy data ino (approxi)							
Waveform span rate (time/div)	15 s	1 min	5 min	10 min	20 min	30 min	1 h
Data saving period	NA	2 s	10 s	20 s	40 s	1 min	2 min
Sampling time	NA	17.9 h	3 days	7 days	14 days	22 days	44 days

Event data file (approx.)

eront data no (approxi)								
Data saving period	25 ms	125 ms	0.5 s	1 s	10 s	30 s	1 min	
Sampling time	NA	22h	87h	17.4 h	7.2 days	21 days	43 days	

Manual sample data:

The measuring and computing data can be saved manually to the internal memory and CF card.

Trigger: Key operation, communication command

or event action function

Data format:

ASCII

Max. number of data:

400 data (if exceeds 400 data, oldest data

is overwritten)

Report data (only for MATH option):

Types: Hourly, daily, hourly + daily, daily + weekly,

and daily + monthly

Data format:

ASCII re: CF card

Drive: CF ca Trigger function:

Selectable from FREE or TRIG for event data saving.

Trigger mode:

Selectable from free, single or repeat

trigger

Data length:

Selectable from 10, 20, 30 min, 1, 2, 3, 4,

6, 8, 12 hour, 1, 2, 3, 5, 7, 10, 14, 31 day Pre trigger: Selectable from 0, 5, 25, 50, 75, 95, 100%

Trigger source:

Key or event action function

Display hard copy:

Trigger: Key operation, communication command

or event action function

Data format:

png format

Drive/output:

CF card or communication interface

Data file retrieving function:

Data file in CF card or USB flash drive (only for USB

option) can be retrieved and displayed.

Retrieved data file:

Display data file or event data file

Saving and retrieving of configuration data:

Configuration information can be saved and retrieved as ASCII data.

Drive: CF card or USB flash drive (only for USB option)

Alarm Function

Number of alarm levels:

Up to four levels for each channel

Alarm types:

High and low limits, differential high and low limits, high and low rate-of-change limits and delay high and low

Alarm delay time:

1 to 3600 s

Interval time of rate-of-change alarms:

The measurement interval times 1 to 32 The alarm status (type) is displayed in the

Display: The alarm status (type) is displayed in the digital value display area upon occurrence of an alarm. A common alarm indication is also

displayed.

Alarming behavior: non-hold or hold-type can be selectable for common to all

channels.

Hysteresis: On/off selectable (common to measurement

channels, mathematical channels or external channels)

0.0 to 5.0% of display span (or scaling span)

Outputs:

Output: Internal switch or relay output (optional)

Number of internal switch:

30 points

Internal switch action:

AND/OR

Number of relay output points:

2, 4 or 6 points (optional)

Relay action:

Energized/deenergized, hold/non-hold, AND/OR, alarm reflash selectable.

Alarm no logging function:

When alarm occurs, only internal switch or relay output is activated. There are no alarm display on screen and no record on alarm summary.

On/off selectable for each channel and

alarm level.

Memory:

The times of alarm occurrences/recoveries, alarm

types, etc. are stored in the memory.

Up to 1000 latest alarm events are stored.

Event action function

General: Particular action can be executed by

particular event.

Number of event action:

40 actions can be set

Event list:

Event	Level/Edge	Description
Remote	Level/Edge	Action by remote control signal
Relay	Level/Edge	Action by relay operation
Internal switch	Level/Edge	Action by internal switch operation
Alarm	Level/Edge	Action by any alarm
Timer	Edge	Action by timer time up
Match time	Edge	Action by time up of match time timer
USER key	Edge	Action by USER key operation

Action list:

Action	Level/Edge	Description
Memory start/stop	Level	Memory start and stop
Memory start	Edge	Memory start
Memory stop	Edge	Memory stop
Event trigger	Edge	Event data sampling start
Alarm ACK	Edge	Alarm ACK
Math start/stop	Level	Computation start and stop
Math start	Edge	Computation start
Math stop	Edge	Computation stop
Math reset	Edge	Computation reset
Manual sample	Edge	Manual sample
Snapshot	Edge	Save display image to external media
Message input	Edge	Message writing
Waveform span rate change	Level	Change waveform span rate
Display data save	Edge	Save currently sampled display data to internal memory as a file
Event data save	Edge	Save currently sampled event data to internal memory as a file
Relative time timer reset	Edge	Reset relative time timer
Display group change	Edge	Change to specified display group
Time adjustment	Edge	Adjust internal clock to the nearest hour
Flag	Level	Normal: "0", Event: "1"
Setting file load	Edge	Load setting file from CF card (up to 3 setting files).

Security functions

General: Login function or key lock function can be set for each key operation or communication operation.

Key lock function:

On/off and password can be set for each operation key and FUNC operation.

Login function:

User name and password to login can be set.

User level and number of users:

System administrator: 5 users
General users: 30 users
10 kinds of login mode can be set for
general users.

Clock

Clock: With calendar function (year of grace) Clock accuracy:

± 10 ppm, excluding a delay (of 1 second, maximum) caused each time the power is turned on.

Time setting method:

Key operation, communication command, event action function or SNTP client function

Time adjustment method:

During memory sample:

Adjust 40 ms per second (No influence for measurement period)

During memory stop:

Adjust at a time

Time zone:

Time difference from GMT:

Settable from -1300 to 1300

Date display format:

Selectable from YYYY/MM/DD, MM/DD/ YYYY, DD/MM/YYYY or DD.MM.YYYY

DST function (summer/winter time):

The time at which the daylight savings time adjustment is automatically calculated and configured.

Communication Functions

Electrical specifications:

Confirms to IEEE802.3 (DIX specification for Ethernet frames)

Connection:

Ethernet (10BASE-T)

Protocols: TCP, UDP, IP, ICMP, ARP, DHCP, HTTP,

FTP, SMTP, SNTP, Modbus, DX private

E-mail inform function:

E-mail is sent by events as below.

- Alarm occurring/alarm canceling
- Recover from power failure
- Memory end
- Storage medium error, FTP client function error
- Specified time period
- Report data time up (only for mathematical option)

FTP client function:

Data file auto-transfer from DX

Transferred data file:

Display data file, event data file, report data file and display image file

FTP server function:

File transfer from DX, file elimination, directory operation and file list output are available by request from host computer. Web server function:

Display image of DX and alarm information can be displayed on web browser software

SNTP client function:

The time on DX can be synchronized to the time of a SNTP server.

SNTP server function:

The DX can operate as a SNTP server.

DHCP client function:

Network address configuration can be obtained automatically from DHCP server.

Obtained information:

IP address, subnet mask, default gateway and DNS information

Modbus client function:

Reading or writing of measurement data on other instruments are available by Modbus protocol.

Mathematical option is required to read the data from other instruments.

Modbus server function:

Output of measurement data from DX is available by Modbus protocol.

Setting/measurement server function:

Operation, setting or output of measurement data are available by DX private protocol.

Maintenance/test server function:

Output connection information or network information of the Ethernet communication.

Instrument information server function:

Output instrument information such as serial number or model name of DX.

Batch function

General: Data display and data management with

batch name, text field function and batch comment function are available.

Batch name:

Batch name can be used as file name of display data, event data and report data.

Batch name format:

Batch number (max. 32 characters) + lot number (max. 8 characters)

Use/not use selectable for lot number, on/ off selectable for auto increment function

Text field function:

Field number:

1 to 8

Field title:

Max. 20 characters

Field text:

Max. 30 characters

Batch comment function:

Batch comment is added to display data and event data.

Batch comment information:

3 comments (max. 50 characters) are available.

Power Supply

Rated power supply:

100 to 240 VAC (automatic switching)

Allowable power supply voltage range:

90 to 132 or 180 to 264 VAC

Rated power supply frequency:

50/60 Hz (automatic switching)

Power consumption:

Supply voltage	LCD off	Normal	Max.
100 VAC	15 VA	24 VA	45 VA
240 VAC	25 VA	32 VA	60 VA

Allowable interruption time:

Less than 1 cycle of power supply frequency

Other Specifications

Memory backup :

A built-in lithium battery backs up the setup parameters and latest measurement data in SRAM (battery life: approximately 10 years at room temperature).

Insulation resistance:

Each terminal to ground terminal:

20 M Ω or greater (at 500 VDC)

Dielectric strength:

Power supply to ground terminal:

2300 VAC (50/60 Hz), 1 min

Contact output terminal to ground terminal:

1600 VAC (50/60 Hz), 1 min

Measuring input terminal to ground terminal:

1500 VAC (50/60 Hz), 1 min

Between measuring input terminals:

1000 VAC (50/60 Hz), 1 min (except for b-terminal of RTD input of DX1006 and

DX1012)

Between remote control terminal to ground terminal:

1000 VDC, 1 min

Safety and EMC Standards

CSA: CSA22.2 No1010.1

Installation category II*1, pollution degree 2*2

UL: UL61010B-1 (CSA NRTL/C)

CE:

EMC directive:

EN61326 compliance (Emission: Class A,

Immunity: Annex A) EN61000-3-2 compliant EN61000-3-3 compliant

EN55011 compliant, Class A Group 1

Low voltage directive:

EN61010-1 compliant, measurement category II^{*3}, pollution degree 2^{*2}

C-Tick: AS/NZS CISPR11 compliant, Class A Group

*1: Installation Category (Overvoltage Category) II

Describes a number which defines a transient overvoltage condition. It implies the regulation for impulse withstand voltage. "II" applies to electrical equipment which is supplied from fixed installations like distribution boards.

*2: Pollution Degree

Describes the degree to which a solid, liquid, or gas which deteriorates dielectric strength or surface resistivity is adhering. "2" applies to normal indoor atmosphere. Normally, only non-conductive pollution occurs.

*3: Measurement Category II Applies to measuring circuits connected to low voltage installation, and electrical instruments supplied with power from fixed equipment such as electric switchboards.

Normal Operating Conditions

Power voltage:

90 to 132 or 180 to 250 VAC

Power supply frequency:

50 Hz ±2%, 60 Hz ±2%

Ambient temperature:

0 to 50 °C

Ambient humidity:

20% to 80% RH (at 5 to 40 °C)

Vibration: 10 to 60 Hz, 0.2 m/s² or less

Shock: Not acceptable

Magnetic field:

400 AT/m or less (DC and 50/60 Hz)

Noise:

Normal mode (50/60 Hz):

DCV: The peak value including the signal must be less than 1.2 times the measuring

range.

TC: The peak value including the signal must be less than 1.2 times the measuring

thermal electromotive force.

RTD: 50 mV or less

Common mode noise voltage (50/60 Hz):

250 Vrms AC or less for all ranges

Maximum noise voltage between channels (50/60 Hz):

250 Vrms AC or less

Mounting position:

Can be inclined up to 30 deg backward. Mounting at an angle away from the perpendicular is not acceptable.

Warm-up time:

At least 30 min after power on

Installation location:

In-room

Altitude: Less than 2000 m

Standard Performance

Measuring and Recording Accuracy:

The following specifications apply to operation of the recorder under standard operation conditions.

Temperature:

23 ± 2 °C

Humidity:

55% ± 10% RH

Power supply voltage:

90 to 132 or 180 to 250 VAC

Power supply frequency:

50/60 Hz ± 1%

Warm-up time:

At least 30 min.

Other ambient conditions such as vibration should not adversely affect recorder operation.

		Measurement accu	Max. resolution of		
Input	16.7ms or		integration time: A/D integration time: 6.7ms or more 1.67ms (fast sampling mode)		
	20 mV	±(0.05% of rdg + 12 digits)	\pm (0.1% of rdg + 40 digits)	1 μV	
	60 mV	. (0.050(() 0.11 ()	./0.40/	10 μV	
DCV	200 mV	\pm (0.05% of rdg + 3 digits)	\pm (0.1% of rdg + 15 digits)	10 μV	
201	2 V	±(0.05% of rdg + 12 digits)	±(0.1% of rdg + 40 digits)	100 μV	
	6 V			1 mV	
	1-5 V	- - ±(0.05% of rdg + 3 digits)	\pm (0.1% of rdg + 15 digits)	1 mV	
	20 V	= ±(0.05% 01 rug + 3 digits)	±(0.1% 01 ldg + 15 digits)	1 mV	
	50 V			10 mV	
	R	±(0.15% of rdg + 1°C) However, R, S:	±(0.2% of rdg + 4°C) However, R, S:		
	S	±3.7°C at 0 to 100°C ±1.5°C at 100 to 300°C B:	±10°C at 0 to 100°C ±5°C at 100 to 300°C B:		
	В	±2°C at 400 to 600°C Accuracy at less than 400°C is not guaranteed.	±7°C at 400 to 600°C Accuracy at less than 400°C is not guaranteed.		
TC (Excluding RJC	К	±(0.15% of rdg + 0.7°C) However, ±(0.15% of rdg + 1°C) at -200 to -100°C	±(0.2% of rdg + 3.5°C) However, ±(0.15% of rdg + 6°C) at -200 to -100°C		
accuracy)	Е			0.1°C	
	J	±(0.15% of rdg + 0.5°C)	±(0.2% of rdg + 2.5°C)		
	Т	However,	However,		
	L	±(0.15% of rdg + 0.7°C) at -200 to -100°C	±(0.2% of rdg + 5°C) at -200 to -100°C		
	U	200 10 100 0	200 10 100 0		
	N	±(0.15% of rdg + 0.7°C)	±(0.3% of rdg + 3.5°C)		
	W	±(0.15% of rdg + 1°C)	±(0.3% of rdg + 7°C)		
	WRe	±(0.2% of rdg + 2.5°C) However, ±4°C at 0 to 200°C	±(0.3% of rdg + 10°C) However, ±18°C at 0 to 200°C		
RTD	Pt100 JPt100	±(0.15% of rdg + 0.3°C)	±(0.3% of rdg + 1.5°C)		

Measurement accuracy in case of scaling (digits):

= measurement accuracy (digits) x scaling span (digits)/measurement span (digits) + 2 digits

Decimals are rounded off to the next highest number.

Reference junction compensation:

INT (internal)/EXT (external) selectable (common for all channels)

Reference junction compensation accuracy:

Types R, S, B, W, WRe: ± 1 °C Types K, J, E, T, N, L, U: ± 0.5 °C (Above 0 °C, input terminal temperature is balanced)

Maximum allowable input voltage:

± 60 VDC (continuous) for all input ranges Input resistance:

Approx. 10 $\text{M}\Omega$ or more for DCV ranges of 200 mVDC or less and TC

Approx. 1 M Ω for more than 2 VDC ranges

Input source resistance:

DCV, TC: $2 k\Omega$ or less

RTD: 10 Ω or less per wire (The resistance of all three wires must be equal.)

Input bias current:

10 nA or less (approx. 100nA for TC range with burnout function)

Maximum common mode noise voltage:

250 Vrms AC (50/60 Hz)

Maximum noise voltage between channels:

250 Vrms AC (50/60 Hz)

Interference between channels:

120 dB (when the input source resistance is 500 Ω and the inputs to other channels are 60 V)

Common mode rejection ratio:

A/D integration time 20 ms:

More than 120 dB (50 Hz \pm 0.1%, 500 Ω imbalance between the minus terminal and ground)

A/D integration time 16.7 ms:

More than 120 dB (60 Hz \pm 0.1%, 500 Ω imbalance between the minus terminal and ground)

A/D integration time 1.67 ms:

More than 80 dB (50/60 Hz \pm 0.1%, 500 Ω imbalance between the minus terminal and ground)

Normal mode rejection ratio:

A/D integration time 20 ms:

More than 40 dB (50 Hz \pm 0.1%)

A/D integration time 16.7 ms:

More than 40 dB (60 Hz \pm 0.1%)

A/D integration time 1.67 ms:

50/60Hz is not rejected.

Effects of Operating Conditions

Ambient temperature: (Only for 16.7 ms A/D integration time or more)

With temperature variation of 10 °C

DCV, TC: \pm (0.1% of rdg + 0.05% of

range) or less

Excluding the error of reference junction

compensation

RTD: \pm (0.1% of rdg + 2 digits) or less

Power supply:

With variation within 90 to 132 V and 180 to 250 VAC (50/60 Hz):

Within measurement accuracy

With variation of ± 2 Hz from rated power frequency (at 100 VAC):

Within measurement accuracy

Magnetic field:

AC (50/60 Hz) and DC 400 A/m fields:

 \pm (0.1% of rdg + 10 digits) or less

Input source resistance:

(1) DCV range (with variation of +1 $k\Omega$)

200 mVDC range or less:

 \pm 10 μ V or less

2 VDC range or greater:

± 0.15% of rdg or less

(2) TC range (with variation of +1 $k\Omega$)

 $\pm 10 \mu V$

(3) RTD range (Pt100)

With variation of 10 Ω per wire (resistance of all three wires must be equal):

 \pm (0.1% of rdg + 1 digit) or less

With maximum difference of 40 m Ω between wires:

approx. ± 0.1 °C

Transport and Storage Conditions

The following specifies the environmental conditions required during transportation from shipment to the start of service and during storage as well as during transportation and storage if this instrument is temporarily taken out of service.

No malfunction will occur under these conditions without serious damage, which is absolutely impossible to repair; however, calibration may be necessary to recover normal operation performance.

Ambient temperature:

-25 °C to 60 °C

Humidity: 5% to 95% RH (No condensation is

allowed.)

Vibration: 10 to 60 Hz, 4.9 m/s² maximum

Shock: 392 m/s² maximum (while being packed)

SPECIFICATIONS OF OPTIONAL FUNC-TIONS

Alarm Output Relays (/A1, /A2, /A3)

An alarm signal is output from the rear panel as a relay contact signal.

Number or output:

Select from 2, 4 and 6 points

Relay contact rating:

250 VDC/0.1 A (for resistance load), 250 VAC (50/60 Hz)/3 A

Terminal configuration:

SPDT (NO-C-NC). Energized-at-alarm/

deenergized-at-alarm,

AND/OR, and hold/non-hold actions are selectable.

Serial Communication Interface (/C2, /C3)

Connection:

EIA RS-232 (/C2) or RS-422A/485 (/C3)

Protocols: DX private protocol, Modbus(master/slave)

protocol

Synchronization method:

Start-stop asynchronous transmission

Connection method (RS-422A/485):

4-wire half-duplex multi-drop connection

(1: N, N = 1 to 31)

Transmission speed:

1200, 2400, 4800, 9600, 19200 or 38400

bps

Data length:

7 or 8 bits

Stop bit: 1 bit

Parity: Odd, even, or none

Communication distance (RS-422A/485):

Up to 1.2 km

Communication mode:

ASCII for input/output for control and setting ASCII or binary for output of measured data

Setting/measurement server function:

Operation, setting or output of measurement data are available by DX private protocol.

Modbus communication:

Reading or writing of measurement data on other instruments are available by Modbus protocol

Mathematical function option is needed to read measurement data from other instruments.

Operation mode:

RTU MASTER or RTU SLAVE

Modbus master command number:

1 to 16

Fail/Status Output (/F1)

The relay contact output on the rear panel indicates the occurrence of CPU failure or selected status.

FAIL output relay:

The relay contact output on the rear panel indicates the occurrence of CPU failure. Relay operation: CPU normal: Energized,

CPU failure: Deenergized

Status output relay:

The relay contact output on the rear panel indicates the occurrence of selected status Relay operation: Status detection:

Energized

Status	Description
Memory status	Relay is energized when inrenal memory or external
	storage media is in the following conditions:
	Abnormality in the inteernal memory
	When automatic saving of settings to the external
	storage media is ON
	When the remaining space on the external storage medium reaches 10%.
	When an abnormality occurs with the external storage medium, and auto save fails
	When the external storage medium is not inserted,
	operation is same as when automatic saving of
	settings to the external storage media is Off
	When automatic saving of settings to the external
	storage media is Off
	When the remaining space on the internal memory reaches 10%
	When the number of data file which is not saved
	to external storage media exceeds 390
	*Not including USB memory connected to the instrument.
Measurement	Relay energized upon A/D converter abnormality or
Failure	burnout detection
Comm. failure	Relay energized when communication error occurs in
	the Modbus master
Memory stop	Relay energized upon memory stop

Relay contact rating:

250 VDC/0.1 A (for resistance load), 250 VAC (50/60 Hz)/3A

Clamped Input Terminal (/H2)

Clamped input terminal (detachable type) is used for input terminal.

Available wire size:

0.08 to 1.5 mm² (AWG28 to16)

Desk Top Type (/H5[])

Provides carrying handle and power cord.

Mathematical Functions (/M1)

Used for calculating data, displaying trends and digital values, and recording calculated data assigned to channels.

Channel assignable to calculated data:

DX1002, DX1004:

Up to 12 channels (101 to 112)

DX1006, DX1012:

Up to 24 channels (101 to 124)

Max. character length of expression:

120 characters

Operation:

General arithmetic operations:

Four arithmetic operations, square root, absolute, common logarithm, natural logarithm, exponential, power, relational operations (>, \geq , <, \leq , =, \neq), logic operations (AND, OR, NOT, XOR)

Statistical operations:

TLOG (Average, maximum, minimum, summation and P-P value of time series data)

CLOG (Average, maximum, minimum, summation and P-P value of channel series data)

Special operations:

PRE (Previous data)

HOLD(a):b (Hold data of "b" in case of "a"

is not "0")

RESET(a):b (Reset data of "b" and restart

in case of "a" is not "0")

CARRY(a):b (If "b" exceeds "a", "b-a"

becomes computation results)

Conditional operation:

[a?b:c] (Execute "b" in case of "a" is not "0", or execute "c" in case of "a" is "0")

Constant: Up to 60 constants (K01 to K60) Digital data input via communication:

Up to 60 data (C01 to C60)

External input:

Up to 240 data (201 to 440) (only for

external input option)

Remote status input:

Remote input status (0/1) can be used in mathematical expression

Up to 8 inputs (D01 to D08)

Pulse input: Up to 8 pulse count input (P01 to P08, Q01

to Q08) (only for pulse input option)

Status input:

Internal switch status (S01 to S30), relay status (I01 to I06) and flag status (F01 to F08) can be used in mathematical expression

Cu10, Cu25 RTD Input /3 leg isolated RTD Input (/N1)

This option allows Cu10 and Cu25 inputs to be added to the standard input types.

A, B, b legs are of isolated input type for DX1006, and DX1012.

Input type Measuring range:

The following specifications apply to operation of the recorder under standard operation conditions.

Temperature:

23 ± 2 °C

Humidity:

55% ± 10% RH

Report functions:

Number of report channels:

DX1002, DX1004: up to 12 channels DX1006, DX1012: up to 24 channels

Report type:

Hourly, daily, hourly + daily, daily +weekly and daily + monthly

Operation:

Max. 4 types are selectable from average, maximum, minimum, instantaneous and summation

Data format:

ASCII

Long term rolling average:

Computation interval:

1, 2, 3, 4, 5, 6, 10, 12, 15, 20, 30 sec., 1, 2, 3, 4, 5, 6, 10, 12, 15, 20, 30, 60 min

Number of sampling:

1 to 1500

Power supply voltage:

90 to 132 or 180 to 250 VAC

Power supply frequency:

 $50/60 \text{ Hz} \pm 1\%$

Warm-up time:

At least 30 min.

Other ambient conditions such as vibration should not adversely affect recorder operation.

		Management	Accuracy	Measuren	Max. resoluti	
Input	Туре	Measurement range	guarantee d range	A/D integration time: 16.7 ms or more	A/D integration time: 1.67ms (Fast sampling mode)	on of digital display
	Cu10 (GE)	-	-70 to 170°C			0.1°C
	Cu10 (L&N)		-75 to 150°C	±(0.4% of rdg + 1.0°C)	±(0.8% of rdg + 5.0°C) RTD	
RTD *1	Cu10 (WEED)		-200 to 260°C			
	Cu10 (BAILEY)					
	Cu10:α =0.00392 at 20°C					
	Cu10:α =0.00393 at 20°C		-200 to 300°C			
	Cu25:α =0.00425 at 0°C		000 0	±(0.3% of rdg + 0.8°C)	±(0.5% of rdg + 2.0°C)	

^{*1} Measuring current: i = 1mA

Input source resistance:

1 Ω or less per wire (The resistance of all three wires must be equal.)

Ambient temperature: (Only for 16.7 ms A/D integration time or more)

With temperature variation of 10 °C

± (0.2% of rdg + 2 digits) or less

Input source resistance:

With variation of 1 Ω per wire (resistance of all three wires must be equal):

 \pm (0.1% of rdg + 1 digit) or less

With maximum difference of 40 m Ω between wires:

approx. ± 1 °C

3 legs Isolated RTD Input (/N2)

A, B, b legs are of isolated input type.

* Can be specified only for DX1006 and DX1012.

A, B, b legs of DX1002 and DX1004 are isolated as standard.

Extended Input Types (/N3)

This option allows extra inputs types to be added to the standard input types.

Input type Measuring range:

The following specifications apply to operation of the recorder under standard operation conditions.

Temperature:

23 ± 2 °C

Humidity:

55% ± 10% RH

Power supply voltage:

90 to 132 or 180 to 250 VAC

Power supply frequency:

50/60 Hz ± 1%

Warm-up time:

At least 30 min.

Other ambient conditions such as vibration should not adversely affect recorder operation.

			Measurement	Measurement accuracy			
Input	Туре	Measurement range	A/D integration time: 16.7 ms or more	A/D integration time: 1.67ms (Fast sampling mode)	on of digital display		
	Kp vs Au7Fe	0.0 to 300.0K	Within ±4.5K at 0 to 20K Within ±2.5K at 20 to 300K	Within ±13.5K at 0 to 20K Within ±7.5K at 20 to 300K	0.1 K		
TC	PLATINEL	0.0 to 1400.0°C	±(0.25% of rdg+2.3°C)	±(0.25% of rdg+8.0°C)			
	PR40-20	0.0 to 1900.0°C	Accuracy is not guaranteed at 0 to 450°C ±(0.9% of rdg+3.2°C) at 450 to 750°C ±(0.9% of rdg+1.3°C) at 750 to 1100°C ±(0.9% of rdg+0.4°C) at 1100 to 1900°C	Accuracy is not guaranteed at 0 to 450°C ±(0.9% of rdg+15.0°C) at 450 to 750°C ±(0.9% of rdg+6.0°C) at 750 to 1100°C ±(0.9% of rdg+3.0°C) at 1100 to 1900°C	0.1°C		
	NiNiMo	0.0 to 1310.0°C	±(0.25% of rdg+0.7°C)	±(0.5% of rdg+3.5°C)	0.1%		
	W/WRe	0.0 to 2400.0°C	±15.0°C at 0 to 400°C ±(0.2%of rdg+2.0°C) at 400 to 2400°C	±30.0°C at 0 to 400°C ±(0.4%of rdg+4.0°C) at 400 to 2400°C			
	TypeN(AWG14)	0.0 to 1300.0°C	±(0.2% of rdg+1.3°C)	±(0.5% of rdg+7.0°C)			
	Pt50	-200.0 to 550.0°C	±(0.3% of rdg+0.6°C)	±(0.6% of rdg+3.0°C)			
	Ni100(SAMA)	-200.0 to 250.0°C	±(0.15% of rdg+0.4°C)	±(0.3% of rdg+2.0°C)			
	Ni100(DIN)	-60.0 to 180.0°C	±(0.15% of rdg+0.4°C)	±(0.3%of rdg+2.0°C)			
	Ni120	-70.0 to 200.0°C	±(0.15% of rdg+0.4°C)	±(0.3% of rdg+2.0°C)			
RTD *1	J263*B	0.0 to 300.0 K	Within ±3.0K at 0 to 40K Within ±1.0K at 40 to 300K	Within ±9.0K at 0 to 40K Within ±3.0K at 40 to 300K	0.1 K		
	Cu53	-50.0 to 150.0°C	±(0.15% of rdg+0.8°C)	±(0.3% of rdg+4.0°C)			
	Cu100	-50.0 to 150.0°C	±(0.2% of rdg+1.0°C)	±(0.4% of rdg+5.0°C)	0.1°C		
	Pt25	-200.0 to 550.0°C	±(0.15% of rdg+0.6°C)	±(0.3% of rdg+3.0°C)			

^{*1} Measuring current: i = 1mA

Input source resistance:

TC: $2 k\Omega$ or less

RTD: 1 Ω or less per wire (The resistance of all three wires must be equal.)

Ambient temperature: (Only for 16.7 ms A/D integration time or more)

With temperature variation of 10 °C

TC: ± (0.1% of rdg + 0.05% of range) or less Excluding the error of reference junction compensation.

RTD: ± (0.2% of rdg + 2 digits) or less

Input source resistance:

(1) TC range (with variation of + 1 k Ω)

 $\pm 10 \,\mu V$

(2) RTD range

With variation of 1 Ω per wire (resistance of all three wires must be equal):

 \pm (0.1% of rdg + 1 digit) or less

With maximum difference of 100 m Ω between wires:

approx. ± 1 °C

Remote Control (/R1)

This option allows eight functions to be controlled remotely by a contact input.

Please refer the part of "Event action function" for functions to be controlled.

24 VDC transmitter power supply (/TPS2, /TPS4)

Output voltage:

22.8 to 25.2 VDC (rated load current)

Rated output current:

4 to 20 mADC

Max. output current:

25 mADC (current to guard operation against overcurrent: approx. 68 mADC)

Allowable conductor resistance:

 $RL \le (17.8 - transmitter minimum operation voltage)/0.02 A (not include drop voltage with load shunt resistance)$

Max. length of wiring:

2 km (CEV cable)

Insulation resistance:

output terminal to grand terminal more than 20 $M\Omega$ (500 VDC)

Dielectric strength:

output terminal to grand terminal:

500 VAC (50/60 Hz, I = 10 mA), 1 min

Between output terminal:

500 VAC (50/60 Hz, I = 10 mA), 1 min

Easy text entry (/KB1, /KB2)

Normal operating conditions:
Ambient temperature for usage:

0 to 40 °C

Ambient humidity for usage:

20 to 80% RH (When to 40 °C, no condensation)

Ambient temperature for storage:

-10 to 60 °C

Power supply:

AA dry battery × 2

Weight: Approx. 60 g (excluding dry battery) Dimensions: 170 (W) \times 50 (H) \times 23.7 (D) mm Number of units that can be controlled:

Max. 32 units by ID setting

Communication distance:

Max. 8 m (depending on battery strength

and usage area)

Orientation specifications:

Depends on battery strength & usage area

USB interface (/USB1)

USB interface specification:

Based on Rev1.1, host function

Number of ports:

2 ports (Front and rear panel)

Power supply:

5V, 500mA (for each port)*1

Available USB devices:

Keyboard:

104/89 keyboard (US) based on USB HID Class Ver.1.1

External medium:

USB flash drive (some of USB flash drives may not be supported by DXAdvanced)

*1: For low powered devices (bus power < 100 mA):

 $5V \pm 5\%$

For high powered devices (bus power < 500 mA):

 $5V \pm 10\%$

Devices which need more than 500 mA total bus power for 2 ports can not be connected at the same time.

Pulse input (/PM1)

Pulse input option includes mathematical functions option (/M1) and remote control option (/R1).

Number of inputs:

3 points (8 points are available in case of using remote inputs)

Input format:

Photocoupler isolation (shared common) Isolated power supply for input terminal (approx. 5 V)

Input type:

Non-voltage contact:

Close: 200 Ω or less, Open: 100 k Ω or

more

Open collector:

ON: 0.5 V or less (30 mADC), Leakage current of OFF: 0.25 mA or less

Counting: Counts rising edges of pulses

Allowable input voltage:

30 VDC

Max. sampling pulse period:

Max.100 Hz

Minimum pulse length:

5 ms

Pulse detection period:

Approx. 3.9 ms (256Hz)

Pulse measuring accuracy:

±1 pulse (for instantaneous mode)

Pulse count period:

Counts the number of pulse per measurement period (P01 to P08) or per second (Q01 to Q08).

Calibration correction function (/CC1)

Corrects the measurement value of each channel using segment linearizer approximation.

Number of segment points:

2 to 16

APPLICATION SOFTWARE

DAQSTANDARD for DXAdvanced

Operating environment

OS: Microsoft Windows 2000/XP

Processor: Pentium II 333 MHz or higher (Pentium III

600 MHz or higher recommended)

Memory: Free area of 32 MB or more (128 MB or

more recommended)

Disk device:

CD-ROM drive that is applied to Windows

2000/XP

Hard disk: Free area of at least 100 MB

Display card:

Compatible with Windows 2000/XP

Can display 32,000 colors or higher (64,000

colors or higher recommended)

Printer: A printer and printer driver compatible with

Windows 2000/XP

Basic function (packages)

Configuration software:

External memory medium: configuration of setting and

basic setting mode

Configuration via communication: configuration of setting and basic setting mode without communication configuration (ex. IP address)

Data viewer software:

Numbers of display channels:

32 channels for each group, at most 50

groups

Display function:

Waveform display, digital display, circular display, list display, report display etc.

File connection display:

Connect data files that are divided because of auto-save during continuous data collecting or power failure, and then display (can connect up to total 5 million)

Section computation:

Maximum, minimum, average, effective and P-P value

Data conversion:

File conversion to ASCII, Lotus 1-2-3 or

MS-Excel format

Print out:

Print out displayed data

MODEL AND SUFFIX CODES

Model code	Su	ffix co	ode	Optional code	Description
DX1002					2ch, 125ms (Fast sampling mode: 25ms)
DX1004					4ch, 125ms (Fast sampling mode: 25ms)
DX1006					6ch, 1s (Fast sampling mode: 125ms)
DX1012					12ch, 1s (Fast sampling mode: 125ms)
Internal memory	-1				Standard memory (80MB)
	-2				Large memory (200MB)
External media		-4			CF card (with media)
Display language		Π-	2		English, degF, DST(summer/winter time)
Options				/A1	Alarm output 2 points *1
				/A2	Alarm output 4 points *1
				/A3	Alarm output 6 points *1 *2
				/C2	RS-232 interface *3
				/C3	RS-422A/485 interface *3
				/F1	FAIL/Status output *2
				/H2	Clamped input terminal (detachable)
				/H5[]	Desktop type *4
				/M1	Mathematical functions
				/N1	Cu10,Cu25 RTD input/3 leg isolated RTD
				/N2	3 leg isolated RTD *5
				/N3	Extended input type (PR40-20, Pt50, etc.)
				/R1	Remote control
				/TPS2	24VDC transmitter power supply (2 loops) *6
				/TPS4	24VDC transmitter power supply (4 loops) *7
				/KB1	Easy text entry (with input terminal) *8 *9
				/KB2	Easy text entry (without input terminal) *8
				/USB1	USB interface
				/PM1	Pulse input (including remote control and mathematical functions) *10
				/CC1	Calibration correction function

^{*1 /}A1, /A2, /A3 cannot be specified together.
*2 /A3 and /F1 cannot be specified together.
*3 /C2 and /C3 cannot be specified together.
*4 /H5[]

D: Power cord UL, CSA st'd

F: Power cord VDE st'd

- R: Power cord SAA st'd

- J: Power cord BS st'd

Application Software

Model code		Description	os	
	DXA120	DAQSTANDARD for DXAdvanced	Windows 2000/XP	

^{*5 /}N2 can be specified for only DX1006 and DX1012.

*6 In case that /TPS2 is specified, /TPS4, /A2, /A3 or /F1 cannot be specified together.

*7 In case that /TPS4 is specified, /TPS2, /A1, /A2, /A3 or /F1 cannot be specified together.

^{*8 /}KB1 and /KB2 cannot be specified together.

^{*9} In case that /KB1 is specified, remote input terminal (438227) is included.
*10 In case that /PM1 is specified, /A3, /M1, /R1, /TPS2 or /TPS4 cannot be specified. And combination of /A2/F1 cannot be specified together.

STANDARD ACCESSORIES

Product	Qty
Mounting brackets	2
Terminal screws	5
Door lock key	2
Operation guide	1
Instruction manual (CD-ROM)	1
DAQSTANDARD software (CD-ROM)	1
CF card (32MB)	1
Power cable *1	1

^{*1} For /H5[] option

For / KB1 option

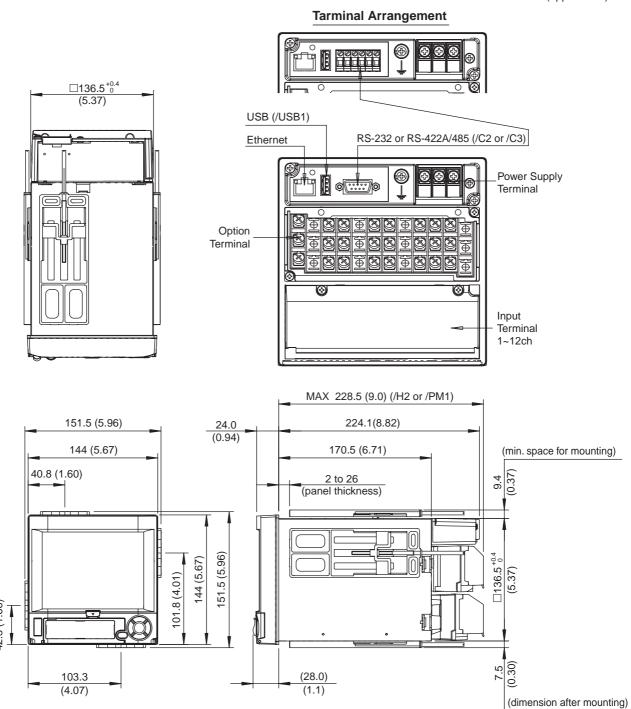
Product	Qty
Remote control terminal (438227)	1
AA alkali dry battery	2
Labels for remote control terminal	2

OPTIONAL ACCESSORIES

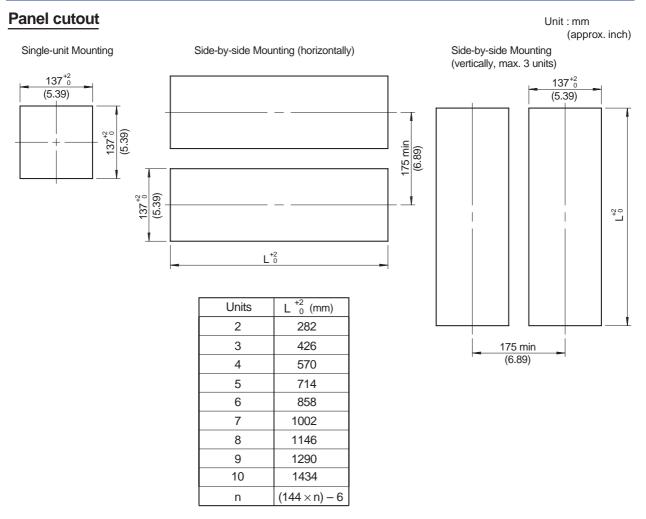
Product	Model code (part number)	Specification
Shunt resister (for screw input	415920	250 Ω±0.1%
terminal)	415921	100 Ω±0.1%
	415922	10 Ω±0.1%
Shunt resister (for clamped	438920	250 Ω±0.1%
input terminal)	438921	100 Ω±0.1%
	438922	10 Ω±0.1%
CF card adapter	772090	_
CF card	772091	128MB
	772092	256MB
	772093	512MB
	772094	1GB
Mounting bracket	B9900BX	-
Door lock key	B8706FX	_
Remote control terminal	438227	For /KB1, /KB2 option

DIMENSIONS

<u>Unit:mm</u> (approx.inch)



Note: If not specified, the tolerance is $\pm 3\%$. However, for dimentions less than 10mm, the tolerance is ± 0.3 mm.



Note : If not specified, the tolerance is $\pm 3\%$. However, for dimensions less than 10 mm, the tolerance is ± 0.3 mm.

Unit: mm **Dimentions** (approx.inch) **Tarminal Arrangement** 138.8 USB (/USB1) RS-422A/485 (/C3) (5.46)5 Power Supply Terminal Ethernet RS-232 (/C2) **(4)** Option Terminal **©** (**(** Input Terminal 1~12ch MAX 252.5 (9.94)(/H2 or /PM1) 144.3 (5.68)39.3 40 (1.57) 144.3 (5.68) 143 (5.63) 14.4 (0.57)

If not specified, the tolerance is $\pm 3\%$. However, for dimentions less than 10mm, the tolerance is ± 0.3 mm.

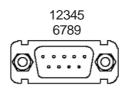
Power Supply Terminal



RS-422-A/485 Terminal

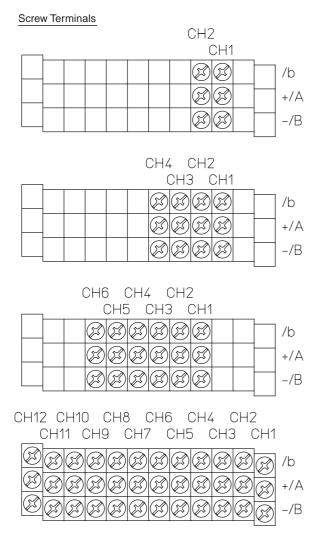
FG SG SDB SDA RDB RDA

RS-232 Terminal

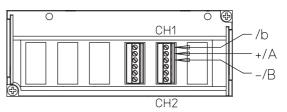


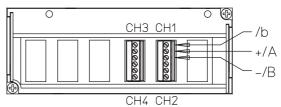
1	N.C.
2	RD
3	SD
4	N.C.
5	SG
6	N.C.
7	RS
8	CS
9	N.C.

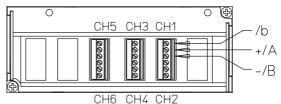
Input Terminals

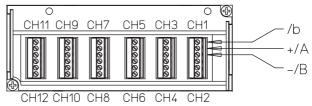


Clamped Terminals (/H2)

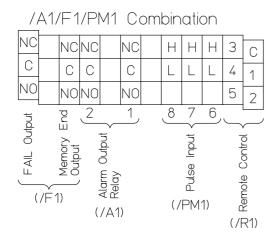


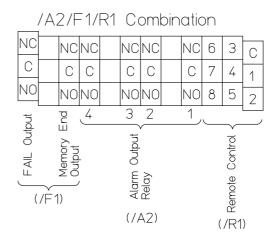


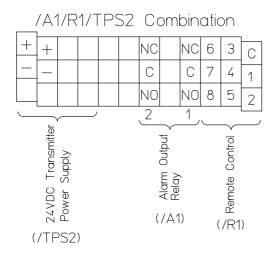


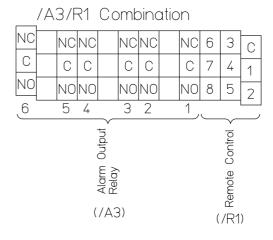


Option Terminals









The TCP/IP software used in this product and the document for that TCP/IP software are based in part on BSD networking software, Release 1 licensed from The Regents of the University of California.

- DAQSTATION is a registered trademark of Yokogawa Electric Corporation.
- Microsoft, MS and Windows are registered trademarks of Microsoft Corporation USA.
- Lotus and 1-2-3 are registered trademark of Lotus Development Corporation.
- Pentium are registered trademarks of Intel Corporation.
- Ethernet is a registered trademark of XEROX Corporation.
- Modbus is a registered trademark of AEG Schneider.
- Other company and/or product names are registered trade mark of their manufactures.